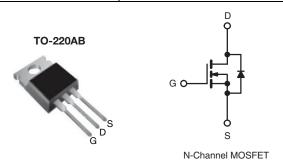
Vishay Siliconix

E Series Power MOSFET

PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	650)	
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.125	
Q _g max. (nC)	130)	
Q _{gs} (nC)	15		
Q _{gd} (nC)	39		
Configuration	Sing	le	



FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
 - LED lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- · Battery chargers
- Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP30N60E-E3
Lead (Pb)-free and Halogen-free	SiHP30N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	600	V		
Gate-Source Voltage		V_{GS}	± 30	V		
Continuous Drain Current (T _{.1} = 150 °C)	\/ at 10 \/	T _C = 25 °C		29		
Continuous Drain Current (1) = 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	I _D	18	Α	
Pulsed Drain Current ^a			I _{DM}	65		
Linear Derating Factor				2	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	690	mJ	
Maximum Power Dissipation			P_{D}	250	W	
Operating Junction and Storage Temperature Range	Э		T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	$V_{DS} = 0 \text{ V to } 80 \text{ % } V_{DS}$		-11.//-14	70	V/ns	
Reverse Diode dV/dt ^d			dV/dt	18	V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s		10 s		300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7 A.
- c. 1.6 mm from case.
- d. $I_{SD} \leq I_{D}, \; dI/dt = 100 \; A/\mu s, \; starting \; T_{J} = 25 \; ^{\circ}C.$



Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.5	C/ VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 250 μA	-	0.64	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	2.8	4.0	V
Cata Cauraa Laglaga		$V_{GS} = \pm 20 \text{ V}$		-		± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	=.	± 1	μΑ
Zoro Coto Voltago Drain Current		V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 600 \	/, V _{GS} = 0 V, T _J = 150 °C	1	-	100	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 15 A	-	0.104	0.125	Ω
Forward Transconductance a	9 _{fs}	V _D	_S = 8 V, I _D = 3 A	-	5.4	-	S
Dynamic							
Input Capacitance	C_{iss}		V _{GS} = 0 V,		2600	-	
Output Capacitance	C_{oss}		$V_{DS} = 100 V,$	ı	138	-]
Reverse Transfer Capacitance	C_{rss}	f = 1.0 MHz		1	3	-	pF
Effective Output Capacitance, Energy Related ^b	$C_{\text{o(er)}}$	- V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	98	-	
Effective Output Capacitance, Time Related ^c	$C_{o(tr)}$			-	346	-	
Total Gate Charge	Qg			-	85	130	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$	$I_D = 15 A, V_{DS} = 480 V$	-	15	-	nC
Gate-Drain Charge	Q _{gd}			-	39	-	
Turn-On Delay Time	t _{d(on)}			ī	19	40	
Rise Time	t _r	$V_{DD} = 380 \text{ V}, I_D = 15 \text{ A}, $ $V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$		-	32	65	ns
Turn-Off Delay Time	$t_{d(off)}$			ı	63	95	7 115
Fall Time	t _f			1	36	75	<u> </u>
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		-	0.63	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	
Pulsed Diode Forward Current	I _{SM}			-	-	65	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V		-	-	1.3	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 15 A, dl/dt = 100 A/μs, V _R = 20 V		-	402	605	ns
Body Diode Reverse Recovery Charge	Q_{rr}			-	7	15	μC
Reverse Recovery Current	I _{RRM}			-	32	65	Α

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

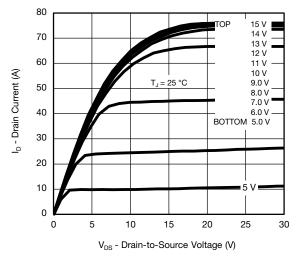


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

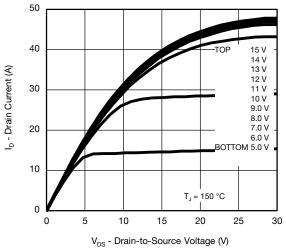


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

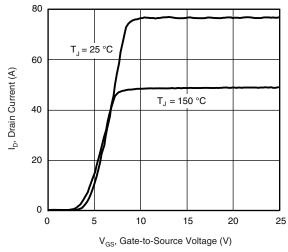


Fig. 3 - Typical Transfer Characteristics

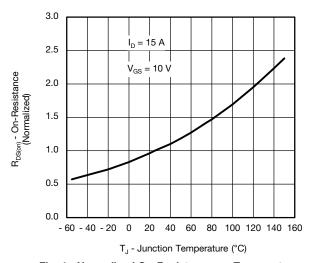


Fig. 4 - Normalized On-Resistance vs. Temperature

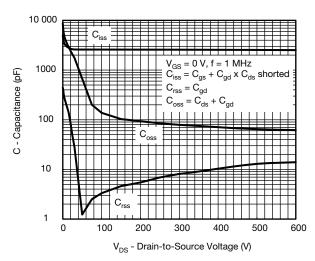


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

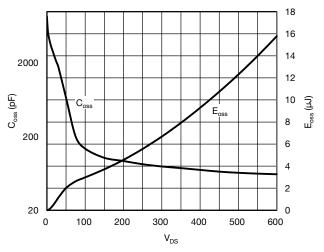


Fig. 6 - Coss and Eoss vs. VDS

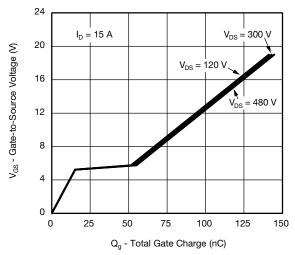


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

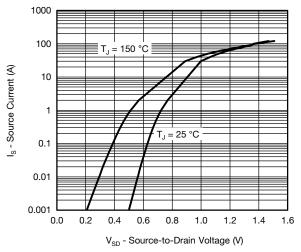


Fig. 8 - Typical Source-Drain Diode Forward Voltage

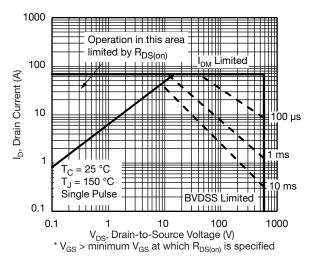


Fig. 9 - Maximum Safe Operating Area

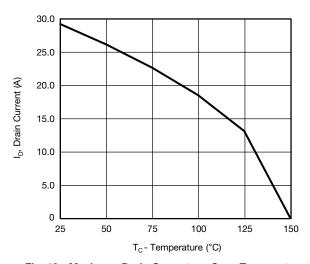


Fig. 10 - Maximum Drain Current vs. Case Temperature

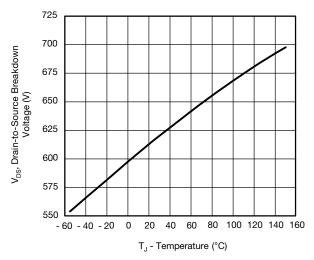
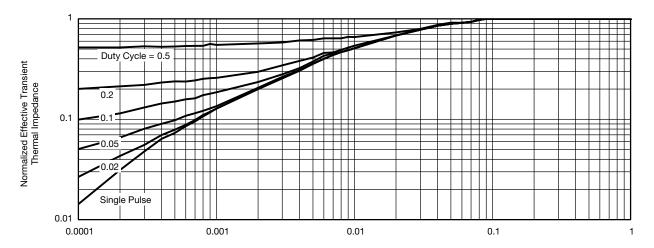
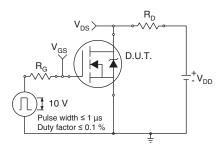


Fig. 11 - Temperature vs. Drain-to-Source Voltage





Square Wave Pulse Duration (s)
Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case



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Fig. 13 - Switching Time Test Circuit

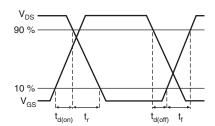


Fig. 14 - Switching Time Waveforms

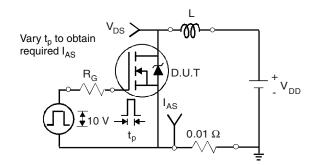


Fig. 15 - Unclamped Inductive Test Circuit

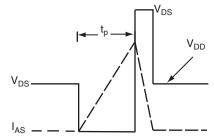


Fig. 16 - Unclamped Inductive Waveforms

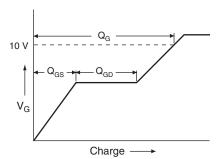


Fig. 17 - Basic Gate Charge Waveform

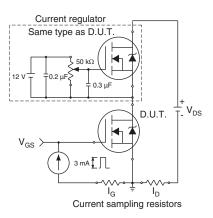
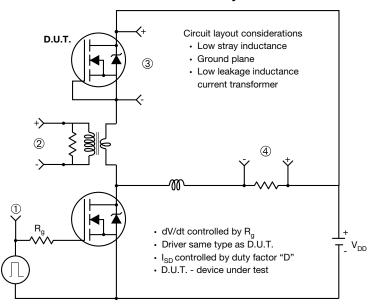


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



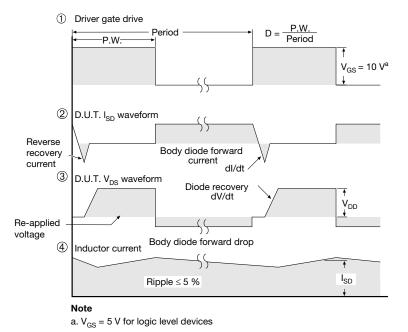
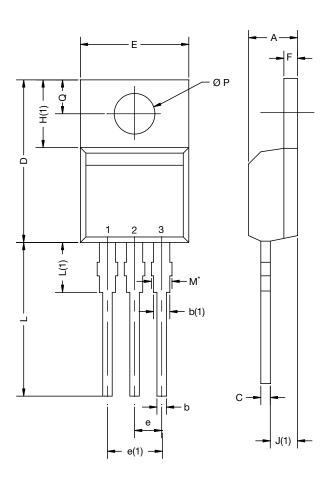


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIM	METERS	INCH	HES
	MIN.	MAX.	MIN.	MAX.
Α	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

DWG: 6031

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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